TOSHIBA

#### TOSHIBA CMOS DIGITAL INTEGRATED CIRCUIT SILICON MONOLITHIC

# **TMPN3120B1AM**

Neuron<sup>®</sup> Chip For Distributed Intelligent Control Networks (LONWORKS®)

The TMPN3120B1AM is a Neuron Chip which configures LONWORKS nodes on a single chip.

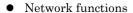
Neuron Chips have all the built-in communications and control functions required to implement LONWORKS nodes.

These nodes may then be easily integrated into highly-reliable distributed intelligent control networks.

The typical functions for this chip are explained below.

#### **FEATURES**

- I / O Functions
  - Eleven programmable I / O pins.
  - Two programmable 16-bit timers and counters built in.
  - 34 different types of I / O functions to handle a wide range of input and output.
  - ROM firmware image containing pre-programmed I / O drivers, greatly simplifying application programs.



- Two CPUs for communication protocol processing built in. The communications and application CPUs execute in parallel.
- Equipped with a built-in LonTalk protocol which supports all seven levels of the OSI reference model with ISO.
- The ROM firmware image contains a complete network operating system, greatly simplifying application programs.
- Built-in twisted-pair wire transceiver
- Equipped with communications modes and communication speeds which support various types of externaltransceivers.
  - Supports twisted-pair wire, power line, radio (RF), infrared, coaxial cables, and fiber optics.
- Communication port transceiver modes and logical addresses stored within the EEPROM. Can be amended via the network.

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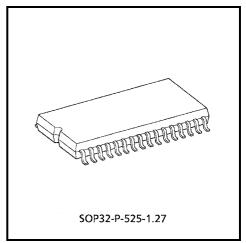
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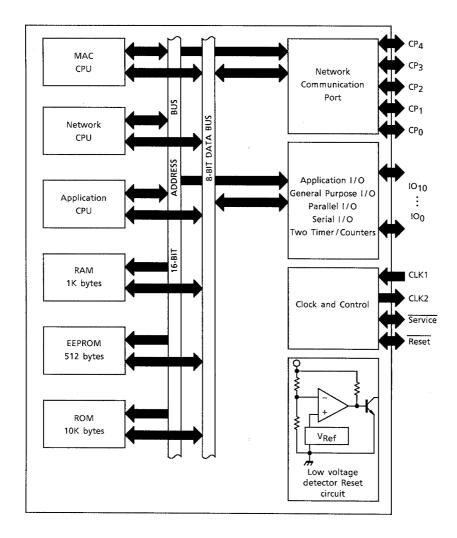


#### • Other functions

- Application programs are also stored within the EEPROM.
   Can be updated by downloading over the network. Up to 400-byte applications can be stored.
- Built-in watch-dog timer.
- Each chip has a unique ID number. Effective during the logical installation of networks.
- Low electrical consumption mode supported with a sleep mode.
- Built-in low-voltage detection circuit.

  Prevents incorrect operations and writing errors in the EEPROM during drops in power voltage.
- The package is SOP32-P-525-1.27.

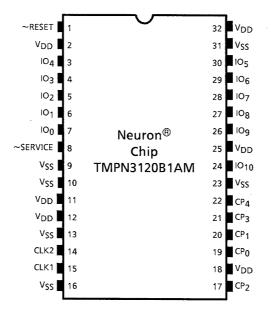
## **BLOCK DIAGRAM**



ITEM	TMPN3120B1AM		
CPU	8-bit CPU×3		
RAM	1,024 bytes		
ROM	10,240 bytes		
EEPROM	512 bytes		
16-bit Timer / Counter	2 channels		
External Memory Interface	Not available		
Package	32-pin SOP		



#### **PIN ASSIGNMENT**



## **PIN FUNCTION**

PIN No.	PIN NAME	1/0	PIN FUNCTION	
15	CLK1	Input	Oscillator connection, or external clock input.	
14	CLK2	Output	Oscillator connection. Leave open when external clock is input to CLK1.	
1	~RESET	I / O (built-in configurable pull-up)	Reset pin. (Active low)	
8	~SERVICE	I / O (built-in configurable pull-up)	Service pin. Indicator output during operation.	
7~4	IO <sub>0</sub> ~IO <sub>3</sub>	1/0	Large current sink capacity (20mA). General I / O port.	
3, 30~28	104~107	I / O (built-in configurable pull-up)	General I / O port. One of $IO_4$ to $IO_7$ can be specified as No.1 timer / counter input. Output signal can be output to $IO_0$ . $IO_4$ can be used as the No.2 timer / counter input with $IO_1$ as output.	
27, 26, 24	IO <sub>8</sub> ~IO <sub>10</sub>	1/0	General I / O port. Can be used for serial communicat with other device.	
2, 11, 12, 18, 25, 32	$V_{DD}$	Input	Power input (5.0V Typ.)	
9, 10, 13, 16, 23, 31	V <sub>SS</sub>	Input	Power input (0V GND)	
19, 20, 17, 21, 22	CP <sub>0</sub> ~CP <sub>4</sub>	1/0	Bidirectional port for communications. Supports several communications protocols by specifying mode.	

- : The ~SERVICE and IO<sub>4</sub> to IO<sub>7</sub> terminals are programmable pull-ups.
  - All V<sub>DD</sub> terminals must be externally connected.
  - All V<sub>SS</sub> terminals must be externally connected.



## MAXIMUM RATINGS ( $V_{SS} = 0V, V_{SS} \text{ typ.}$ )

CHARACTERISTICS	SYMBOL	RATING	UNIT
Power Supply Voltage	$V_{DD}$	-0.3~7.0	V
Input Voltage	V <sub>IN</sub>	-0.3~V <sub>DD</sub> +0.3	V
Power Dissipation	PD	800	mW
Storage Temperature	T <sub>stg</sub>	-65~150	°C

#### **OPERATING CONDITIONS**

ITEM	SYMBOL	MIN	TYP.	MAX	UNIT
Operating Voltage	$V_{DD}$	4.5	5.0	5.5	V
Input Voltage ( TTL )	V <sub>IH</sub>	2.0	_	$V_{DD}$	V
	V <sub>IL</sub>	V <sub>SS</sub>	_	0.8	V
Input Voltage ( CMOS )	V <sub>IH</sub>	V <sub>DD</sub> -0.8	_	$V_{DD}$	V
	V <sub>IL</sub>	V <sub>SS</sub>	_	0.8	V
Operating Frequency	f <sub>osc</sub>	0.625	_	10	MHz
Operating Temperature	T <sub>opr</sub>	-40	_	85	°C

## **ELECTRICAL CHARACTERISTICS**

DC characteristic ( $V_{DD} = 5.0 \text{ V} \pm 10\%$ ,  $V_{SS} = 0 \text{ V}$ ,  $Ta = -40 \sim 85 ^{\circ}\text{C}$ ) ( Above operating conditions apply unless otherwise states. )

CHARACTERISTICS	SYMBOL	PINS	TEST CONDITION		MIN	MAX	UNIT
LOW Output Voltage (1)	V <sub>OL</sub> (1)	IO <sub>0</sub> ~IO <sub>3</sub>	I <sub>OL</sub> =20mA I <sub>OL</sub> =10mA		0	0.8	V
LOW Output Voltage (1)	VOL (1)	100-103			0	0.4	V
LOW Output Voltage (2)	)/ (O)	~SERVICE	Duty	I <sub>OL</sub> =20mA	0	0.8	V
LOW Output Voltage (2)	V <sub>OL</sub> (2)	~3ERVICE	cycle=50%	I <sub>OL</sub> =10mA	0	0.4	V
LOW Output Voltage (3)	V <sub>OL</sub> (3)	CP <sub>2</sub> , CP <sub>3</sub>	I <sub>OL</sub> =40mA	I <sub>OL</sub> =40mA		1.0	V
LOW Output Voltage (4)	V <sub>OL</sub> (4)	Others (Note 1)	I <sub>OL</sub> =1.4mA	I <sub>OL</sub> =1.4mA		0.4	V
HIGH Output Voltage (1)	V <sub>OH</sub> (1)	IO <sub>0</sub> ~IO <sub>3</sub>	I <sub>OH</sub> =-1.4mA		V <sub>DD</sub> -0.4	V <sub>DD</sub>	V
HIGH Output Voltage (2)	V <sub>OH</sub> (2)	~SERVICE	I <sub>OH</sub> =-1.4mA		V <sub>DD</sub> -0.4	V <sub>DD</sub>	V
HIGH Output Voltage (3)	V <sub>OH</sub> (3)	CP <sub>2</sub> , CP <sub>3</sub>	I <sub>OH</sub> =-40mA		V <sub>DD</sub> −1.0	V <sub>DD</sub>	V
HIGH Output Voltage (4)	V <sub>OH</sub> (4)	Others (Note 1)	I <sub>OH</sub> =-1.4mA		V <sub>DD</sub> -0.4	V <sub>DD</sub>	V
Input Current	I <sub>IN</sub>	(Note 2)	V <sub>IN</sub> =V <sub>SS</sub> ~V <sub>DD</sub>		-10	+10	μΑ
Pull-up Current	I <sub>PU</sub>	IO <sub>4</sub> ~IO <sub>7</sub> ~SERVICE, ~RESET (Note 3)	V <sub>IN</sub> =0V		-30	-300	μА
Low-voltage Detection Level	$V_{LVD}$	$V_{DD}$	_		3.8	4.5	V

Note1: Output voltage characteristics exclude the ~RESET pin and CLK2 pin.

Note2: Excludes pull-up input pins.

Note3: The IO<sub>4</sub> to IO<sub>7</sub> and ~SERVICE pins have programmable pull-ups. ~RESET has a fixed pull-up.

ITEM		SYMBOL	TYP.	MAX	UNIT
Operating Mode Current Consumption	10 MHz Clock	IDD (OP)	17	30	mA
	5 MHz Clock		9	15	
	2.5 MHz Clock		6	8	
	1.25 MHz Clock		4	5	
	0.625 MHz Clock		2	3	
Sleep Mode Current Consumption		I <sub>DD (SLP)</sub>	16	100	μΑ

Note: Test conditions for current dissipation

 $V_{DD}$ =5V, all output=with no load, all input=0.2V or below or  $V_{DD}$ =0.2V, programmable pull-up=off, crystal oscillator clock input, differential receiver disabled.

The current value (typ.) is a typical value when Ta=25°C

The current value ( max ) applies to the rated temperature range at  $V_{DD}$ =5.5V.

 $200\mu A$  ( typ. ) to  $600\mu A$  ( max ) is added to the current of the differential receiver when the receiver is enabled.

The differential receiver is enabled by either of the following conditions :

- When the Neuron chip is in Run mode and the communication ports are in Differential mode.
- When the Neuron chip is in Sleep mode, the communication ports are in Differential mode, and the Comm Port Wakeup is not masked.

TOSHIBA TMPN3120B1AM

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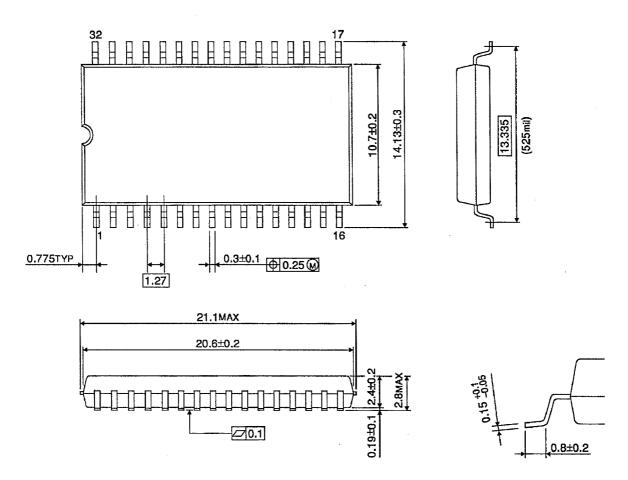
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## **PACKCAGE DIMENSIONS**

SOP32-P-525-1.27 Unit: mm



Weight: 1.0g (Typ.)